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As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD FOR FORMING AN THIN FILM LIGHT EMITTING DEVICE

the specification of v	vhich				
_X is attached her was filed on	eto.				
as Application	Serial No	and was amended on			
specification, including I acknowledge application in accord I hereby claim application(s) for pat	ng the claims, as amende the duty to disclose inf lance with Title 37, Code foreign priority benefits u ent or inventor's certificat t or inventor's certificate h	and understand the contented by any amendment referred formation which is material to of Federal Regulations, § 1.5 ander Title 35, Untied States Cote listed below and have also inaving a filing date before that	d to above. the patent (6(a). (ode, § 119) (dentified belo	tability of this of any foreign ow any foreign	
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No	
90106034	Taiwan, R.O.C.	2001/3/15	×		
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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